## PS9552,PS9552L1,PS9552L2,PS9552L3

### 2.5 A OUTPUT CURRENT, HIGH CMR IGBT GATE DRIVE PHOTOCOUPLER 8-PIN DIP PHOTOCOUPLER

 -NEPOC Series-
## DESCRIPTION

The PS9552, PS9552L1, PS9552L2 and PS9552L3 are optically coupled isolators containing a GaAIAs LED on the input side and a photo diode, a signal processing circuit and a power output transistor on the output side on one chip.

The PS9552 Series is designed specifically for high common mode transient immunity (CMR), high output current and high switching speed.

The PS9552 Series is suitable for driving IGBTs and MOS FETs.
The PS9552 Series is in a plastic DIP (Dual In-line Package).
The PS9552L1 is lead bending type for long creepage distance.
The PS9552L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.
The PS9552L3 is lead bending type (Gull-wing) for surface mounting.

## FEATURES

- Long creepage distance (8 mm MIN.: PS9552L1, PS9552L2)
- Large peak output current (2.5 A MAX., 2.0 A MIN.)
- High speed switching (tpLH, tPHL $=0.5 \mu \mathrm{~s}$ MAX.)
- UVLO (Under Voltage Lock Out) protection with hysteresis
- High common mode transient immunity (CMн, CML $= \pm 25 \mathrm{kV} / \mu \mathrm{s} \mathrm{MIN}$.)
- Ordering number of tape product: PS9552L2-E3: $1000 \mathrm{pcs} / \mathrm{reel}$
: PS9552L3-E3: 1000 pcs/reel
- Pb-Free product
- Safety standards

- UL approved: No. E72422
- CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22. 2 60065, 60950)
- BSI approved: No. 8937, 8938
- SEMKO approved: No. 615433
- NEMKO approved: No. P06207243
- DEMKO approved: No. 314091
- FIMKO approved: No. FI 22827
- DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40019182 (Option)


## APPLICATIONS

- IGBT, Power MOS FET Gate Driver
- Industrial inverter
- IH (Induction Heating)

[^0] that this is the latest version.
<R> PACKAGE DIMENSIONS (UNIT: mm)
DIP Type


Lead Bending Type (Gull-wing) For Surface Mount


## Lead Bending Type For Long Creepage Distance



Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)


## PHOTOCOUPLER CONSTRUCTION

| Parameter | PS9552, PS9552L3 | PS9552L1, PS9552L2 |
| :--- | :---: | :---: |
| Air Distance (MIN.) | 7 mm | 8 mm |
| Outer Creepage Distance (MIN.) | 7 mm | 8 mm |
| Isolation Distance (MIN.) | 0.4 mm | 0.4 mm |

## FUNCTIONAL DIAGRAM


<R>
MARKING EXAMPLE


## ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number*1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| PS9552 | PS9552-AX | Pb-Free <br> ( $\mathrm{Ni} / \mathrm{Pd} / \mathrm{Au}$ ) | Magazine case 50 pcs | Standard products (UL, CSA, BSI, SEMKO, NEMKO, DEMKO, FIMKO approved) | PS9552 |
| PS9552L1 | PS9552L1-AX |  |  |  | PS9552L1 |
| PS9552L2 | PS9552L2-AX |  |  |  | PS9552L2 |
| PS9552L3 | PS9552L3-AX |  |  |  | PS9552L3 |
| PS9552L2-E3 | PS9552L2-E3-AX |  | Embossed Tape $1000 \mathrm{pcs} / \mathrm{reel}$ |  | PS9552L2 |
| PS9552L3-E3 | PS9552L3-E3-AX |  |  |  | PS9552L3 |
| PS9552-V | PS9552-V-AX |  | Magazine case 50 pcs | DIN EN60747-5-2 <br> (VDE0884 Part2) <br> Approved (Option) | PS9552 |
| PS9552L1-V | PS9552L1-V-AX |  |  |  | PS9552L1 |
| PS9552L2-V | PS9552L2-V-AX |  |  |  | PS9552L2 |
| PS9552L3-V | PS9552L3-V-AX |  |  |  | PS9552L3 |
| PS9552L2-V-E3 | PS9552L2-V-E3-AX |  | Embossed Tape 1000 pcs/reel |  | PS9552L2 |
| PS9552L3-V-E3 | PS9552L3-V-E3-AX |  |  |  | PS9552L3 |

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified)

| Parameter |  | Symbol | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Diode | Forward Current | IF | 25 | mA |
|  | Peak Transient Forward Current (Pulse Width < $1 \mu s$ ) | If (tran) | 1.0 | A |
|  | Reverse Voltage | $V_{\text {R }}$ | 5 | V |
| Detecto r | High Level Peak Output Current ${ }^{* 1}$ | ІОН (РЕАК) | 2.5 | A |
|  | Low Level Peak Output Current ${ }^{* 1}$ | Iol (PEAK) | 2.5 | A |
|  | Supply Voltage | (Vcc- $\mathrm{Vee}^{\text {e }}$ ) | 0 to 35 | V |
|  | Output Voltage | Vo | 0 to Vcc | V |
|  | Power Dissipation ${ }^{*}$ | Pc | 250 | mW |
| Isolation Voltage ${ }^{\text {* }}$ |  | BV | 5000 | Vr.m.s. |
| Total Power Dissipation ${ }^{* 4}$ |  | $\mathrm{P}_{\text {t }}$ | 300 | mW |
| Operating Frequency ${ }^{*}$ |  | f | 50 | kHz |
| Operating Ambient Temperature |  | TA | -40 to +100 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | $\mathrm{T}_{\text {stg }}$ | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |

*1 Maximum pulse width $=10 \mu \mathrm{~s}$, Maximum duty cycle $=0.2 \%$
*2 Reduced to $4.8 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ at $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ or more.
*3 AC voltage for 1 minute at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{RH}=60 \%$ between input and output.
Pins 1-4 shorted together, 5-8 shorted together.
*4 Reduced to $5.4 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ at $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ or more.
*5 lOH (РЕАК) $\leq 2.0 \mathrm{~A}(\leq 0.3 \mu \mathrm{~s})$, loL (PEAK) $\leq 2.0 \mathrm{~A}(\leq 0.3 \mu \mathrm{~S})$

## RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage | $\left(\mathrm{V}_{\mathrm{cc}}-\mathrm{VEE}^{\prime \prime}\right.$ | 15 |  | 30 | V |
| Forward Current (ON) | $\mathrm{IF}_{(\mathrm{ON})}$ | 7 | 10 | 16 | mA |
| Forward Voltage (OFF) | $\mathrm{V}_{\mathrm{F}(\mathrm{OFF})}$ | -2 |  | 0.8 | V |
| Operating Ambient Temperature | $\mathrm{T}_{\mathrm{A}}$ | -40 |  | 100 | ${ }^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=-\mathbf{4 0}$ to $+100^{\circ} \mathrm{C}, \mathrm{Vcc}=15$ to $30 \mathrm{~V}, \mathrm{If}_{\mathrm{F}}(\mathrm{ON})=\mathbf{7}$ to 16 mA , $\mathrm{V}_{\mathrm{F}(\mathrm{OFF})}=\mathbf{- 2}$ to $0.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=\mathrm{GND}$, unless otherwise specified)

| Parameter |  | Symbol | Conditions | MIN. | TYP. ${ }^{1}$ | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Diode | Forward Voltage | $V_{F}$ | $\mathrm{IF}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 1.3 | 1.65 | 2.1 | V |
|  | Input Capacitance | CIN | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{V}_{\mathrm{F}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 30 |  | pF |
| Detector | High Level Output Current | Іон | V o $=(\mathrm{Vcc}-4 \mathrm{~V})^{*}{ }^{2}$ | 0.5 | 2.0 |  | A |
|  |  |  | $\mathrm{V} o=(\mathrm{Vcc}-15 \mathrm{~V})^{* 3}$ | 2.0 |  |  |  |
|  | Low Level Output Current | loL | $\mathrm{V}_{\mathrm{O}}=\left(\mathrm{V}_{\mathrm{EE}}+2.5 \mathrm{~V}\right)^{* 2}$ | 0.5 | 2.0 |  | A |
|  |  |  | $\mathrm{Vo}=(\mathrm{VEE}+15 \mathrm{~V})^{* 3}$ | 2.0 |  |  |  |
|  | High Level Output Voltage | Vor | $\mathrm{lo}=-100 \mathrm{~mA}^{*}$ | Vcc-3.5 | Vcc-2.5 | Vcc-1.5 | V |
|  | Low Level Output Voltage | Vol | $\mathrm{lo}=100 \mathrm{~mA}$ |  | 0.1 | 0.5 | V |
|  | High Level Supply Current | IcCH | $\mathrm{V}_{\mathrm{o}}=$ open, $\mathrm{IF}^{\prime}=7$ to 16 mA |  | 2.0 | 5.0 | mA |
|  | Low Level Supply Current | Iccl | $\mathrm{V}_{\mathrm{o}}=$ open, $\mathrm{V}_{\mathrm{F}}=-2$ to +0.8 V |  | 2.0 | 5.0 | mA |
|  | UVLO Threshold | Vuvlo+ | V O $>5 \mathrm{~V}, \mathrm{IF}=10 \mathrm{~mA}$ | 11.0 | 12.3 | 13.5 | V |
|  |  | Vuvlo- |  | 9.5 | 10.7 | 12.0 |  |
|  | UVLO Hysteresis | UVLOHYs | V o $>5 \mathrm{~V}, \mathrm{l}=10 \mathrm{~mA}$ |  | 1.6 |  | V |
| Coupled | Threshold Input Current $(\mathrm{L} \rightarrow \mathrm{H})$ | Iflh | $\mathrm{lo}=0 \mathrm{~mA}, \mathrm{~V} o>5 \mathrm{~V}$ |  | 2.0 | 5.0 | mA |
|  | Threshold Input Voltage $(\mathrm{H} \rightarrow \mathrm{~L})$ | Vfrl | $\mathrm{lo}=0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{o}}<5 \mathrm{~V}$ | 0.8 |  |  | V |

*1 Typical values at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
*2 Maximum pulse width $=50 \mu \mathrm{~s}$, Maximum duty cycle $=0.5 \%$.
*3 Maximum pulse width $=10 \mu \mathrm{~s}$, Maximum duty cycle $=0.2 \%$
*4 Vон is measured with the DC load current in this testing (Maximum pulse width $=2 \mathrm{~ms}$, Maximum duty cycle $=$ 20\%).

SWITCHING CHARACTERISTICS (TA = -40 to $+100^{\circ} \mathrm{C}, \mathrm{Vcc}=15$ to $30 \mathrm{~V}, \mathrm{If}_{\mathrm{O}}(\mathrm{ON})=7$ to 16 mA , $\mathrm{V}_{\mathrm{F}(\mathrm{OFF})}=\mathbf{- 2}$ to $0.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=\mathrm{GND}$, unless otherwise specified)

| Parameter | Symbol | Conditions | MIN. | TYP. ${ }^{1}$ | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Propagation Delay Time ( $\mathrm{L} \rightarrow \mathrm{H}$ ) | tPLH | $\begin{aligned} & \mathrm{R}_{\mathrm{g}}=10 \Omega, \mathrm{C}_{\mathrm{g}}=10 \mathrm{nF}, \mathrm{f}=10 \mathrm{kHz}, \\ & \text { Duty Cycle }=50 \%^{* 2}, \mathrm{IF}=7 \text { to } 16 \mathrm{~mA} \end{aligned}$ | 0.1 | 0.3 | 0.5 | $\mu s$ |
| Propagation Delay Time ( $\mathrm{H} \rightarrow \mathrm{L}$ ) | tPHL |  | 0.1 | 0.3 | 0.5 | $\mu \mathrm{s}$ |
| Pulse Width Distortion (PWD) | $\mid$ tPhL-tPLH\| |  |  |  | 0.3 | $\mu s$ |
| Propagation Delay Time (Difference Between Any Two Products) | tPHL-tPLH |  | -0.35 |  | 0.35 | $\mu s$ |
| Rise Time | tr |  |  | 0.1 |  | $\mu \mathrm{S}$ |
| Fall Time | tf |  |  | 0.1 |  | $\mu \mathrm{s}$ |
| UVLO (Turn On Delay) | tuvLo on | $\mathrm{V}_{0}>5 \mathrm{~V}, \mathrm{l}=10 \mathrm{~mA}$ |  | 0.8 |  | $\mu s$ |
| UVLO (Turn Off Delay) | tuvlo off | $\mathrm{V}_{0}<5 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ |  | 0.6 |  | $\mu s$ |
| Common Mode Transient Immunity at High Level Output ${ }^{* 3}$ | \|CMH| | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{I}_{\mathrm{F}}=10 \text { to } 16 \mathrm{~mA}, \mathrm{~V} \mathrm{CC}=30 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{o} \text { (MIN.) })}=26 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=1.5 \mathrm{k} \mathrm{~V} \end{aligned}$ | 25 |  |  | $\mathrm{kV} / \mu \mathrm{s}$ |
| Common Mode Transient Immunity at Low Level Output ${ }^{* 3}$ | \|CML| | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{IF}_{\mathrm{F}}=0 \mathrm{~mA}, \mathrm{~V} \mathrm{CC}=30 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{o}}(\mathrm{mAX} .)=1 \mathrm{~V}, \mathrm{~V} \mathrm{CM}=1.5 \mathrm{k} \mathrm{~V} \end{aligned}$ | 25 |  |  | $\mathrm{kV} / \mu \mathrm{s}$ |

[^1]
## TEST CIRCUIT



Fig. 7 tPLh, tpHL, tr, tf Test Circuit and Wave Forms


Fig. 8 CMR Test Circuit and Wave Forms


Remark CMR Test : Connect pin 1 and pin 4 to the LED common.

TYPICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified)


TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE


THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE


DETECTOR POWER DISSIPATION
vs. AMBIENT TEMPERATURE


FORWARD CURRENT vs. FORWARD VOLTAGE


OUTPUT VOLTAGE vs.
FORWARD CURRENT


Remark The graphs indicate nominal characteristics.

HIGH LEVEL OUTPUT VOLTAGE - SUPPLY VOLTAGE vs. HIGH LEVEL OUTPUT CURRENT


High Level Output Current Іон (A)
PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION
vs. FORWARD CURRENT


Forward Current If (mA)
PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE


LOW LEVEL OUTPUT VOLTAGE vs. LOW LEVEL OUTPUT CURRENT



Supply Voltage Vcc (V)
PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. LOAD CAPACITANCE


Remark The graphs indicate nominal characteristics.

SUPPLY CURRENT vs. AMBIENT TEMPERATURE


HIGH LEVEL OUTPUT VOLTAGE - SUPPLY VOLTAGE vs. AMBIENT TEMPERATURE


HIGH LEVEL OUTPUT CURRENT vs. AMBIENT TEMPERATURE


SUPPLY CURRENT vs. AMBIENT TEMPERATURE


LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE


LOW LEVEL OUTPUT CURRENT vs. AMBIENT TEMPERATURE


Remark The graphs indicate nominal characteristics.

PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. LOAD RESISTANCE


OUTPUT VOLTAGE vs. SUPPLY VOLTAGE


[^2]
## TAPING SPECIFICATIONS (UNIT: mm)

## Outline and Dimensions (Tape)



Tape Direction


Outline and Dimensions (Reel)


Packing: 1000 pcs/reel



## RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



| Part Number | Lead Bending | A | B | C | D |
| :---: | :---: | :---: | :---: | :---: | :---: |
| PS9552L2 | lead bending type (Gull-wing) <br> for long creepage distance (surface mount) | 10.2 | 2.54 | 1.7 | 2.2 |
| PS9552L3 | lead bending type (Gull-wing) <br> for surface mount | 8.2 | 2.54 | 1.7 | 2.2 |

## NOTES ON HANDLING

## 1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than $220^{\circ} \mathrm{C}$
- Time to preheat temperature from 120 to $180^{\circ} \mathrm{C}$
$260^{\circ} \mathrm{C}$ or below (package surface temperature)
10 seconds or less
60 seconds or less
- Number of reflows
- Flux
$120 \pm 30 \mathrm{~s}$
Three
Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of $0.2 \mathrm{Wt} \%$ is recommended.)


## Recommended Temperature Profile of Infrared Reflow


(2) Wave soldering

- Temperature
- Time
- Preheating conditions
- Number of times
- Flux
$260^{\circ} \mathrm{C}$ or below (molten solder temperature)
10 seconds or less
$120^{\circ} \mathrm{C}$ or below (package surface temperature)
One (Allowed to be dipped in solder including plastic mold portion.)
Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of $0.2 \mathrm{Wt} \%$ is recommended.)


## (3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) $350^{\circ} \mathrm{C}$ or below
- Time (each pins)
- Flux

3 seconds or less
Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of $0.2 \mathrm{Wt} \%$ is recommended.)
(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
(b) Please be sure that the temperature of the package would not be heated over $100^{\circ} \mathrm{C}$

## (4) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

## 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

## USAGE CAUTIONS

1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. Board designing
(1) By-pass capacitor of more than $0.1 \mu \mathrm{~F}$ is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm .
(2) In older to avoid malfunctions and characteristics degradation, IGBT collector or emitter traces should not be closed to the LED input.
(3) Pins 1, 4 (which is an $\mathrm{NC}^{* 1} \mathrm{pin}$ ) can either be connected directly to the GND pin on the LED side or left open.
Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.
*1 NC: Non-Connection (No Connection)
3. Make sure the rise/fall time of the forward current is $0.5 \mu \mathrm{~s}$ or less.
4. In order to avoid malfunctions, make sure the rise/fall slope of the supply voltage is $3 \mathrm{~V} / \mu \mathrm{s}$ or less.
5. Avoid storage at a high temperature and high humidity.
<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter | Symbol | Spec. | Unit |
| :---: | :---: | :---: | :---: |
| Climatic test class (IEC 60068-1/DIN EN 60068-1) |  | 55/100/21 |  |
| Dielectric strength <br> maximum operating isolation voltage <br> Test voltage (partial discharge test, procedure a for type test and random test) $\mathrm{U}_{\mathrm{pr}}=1.5 \times \text { Ulorm, } \mathrm{Pd}<5 \mathrm{pC}$ | Uiorm <br> Upr | $\begin{aligned} & 1130 \\ & 1695 \end{aligned}$ | $\begin{aligned} & V_{\text {peak }} \\ & V_{\text {peak }} \end{aligned}$ |
| Test voltage (partial discharge test, procedure b for all devices) $\mathrm{U}_{\mathrm{pr}}=1.875 \times$ UIORM, $\mathrm{Pd}<5 \mathrm{pC}$ | Upr | 2119 | $V_{\text {peak }}$ |
| Highest permissible overvoltage | UTR | 8000 | $V_{\text {peak }}$ |
| Degree of pollution (DIN EN 60664-1 VDE0110 Part 1) |  | 2 |  |
| Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11)) | CTI | 175 |  |
| Material group (DIN EN 60664-1 VDE0110 Part 1) |  | III a |  |
| Storage temperature range | T stg | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |
| Operating temperature range | TA | -40 to +100 | ${ }^{\circ} \mathrm{C}$ |
| Isolation resistance, minimum value $\begin{aligned} & V_{10}=500 \mathrm{~V} \text { dc at } T_{A}=25^{\circ} \mathrm{C} \\ & V_{10}=500 \mathrm{~V} \text { dc at } T_{A} \text { MAX. at least } 100^{\circ} \mathrm{C} \end{aligned}$ | Ris MIN. Ris MIN. | $\begin{aligned} & 10^{12} \\ & 10^{11} \end{aligned}$ | $\begin{aligned} & \Omega \\ & \Omega \end{aligned}$ |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) <br> Package temperature <br> Current (input current If, Psi $=0$ ) <br> Power (output or total power dissipation) <br> Isolation resistance $\mathrm{V}_{10}=500 \mathrm{~V} \text { dc at } \mathrm{T}_{\mathrm{A}}=\mathrm{Tsi}$ | Tsi <br> Isi <br> Psi <br> Ris MIN. | $\begin{aligned} & 175 \\ & 400 \\ & 700 \\ & 10^{9} \end{aligned}$ | $\begin{gathered} { }^{\circ} \mathrm{C} \\ \mathrm{~mA} \\ \mathrm{~mW} \end{gathered}$ |

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| :---: | :--- | :--- |

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TLP555(F) HCPL2630SM PS2841-4A-F3-AX PS9817A-1-F3-AX PS9821-2-F3-AX ORPC-817D ORPC-817M/C ORPC-817M/B PT1751C/L129(BIN2) TLP521-4GBSM UMW817C 6N137S1(TA) TLP521GB TLP521GB-S PS2501 PS2501-S TLP785GB TLP785GB-S LTV-214-G TLP2766A(E TLP2766A(LF4,E LCR-0202 EL814S1(TA)-V PC817X4NSZ2B CYPC817 OR-MOC3023 TLP267J(TPL,E(T TLP109(TPL,E(O EL2514S1(TU)(CLW)-G EL816S2(C)(TU)-F EL814S(A)(TU) TLP281-4 MOC3023M ACPL-K49T-060E


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[^1]:    *1 Typical values at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
    *2 This load condition is equivalent to the IGBT load at $1200 \mathrm{~V} / 75 \mathrm{~A}$.
    *3 Connect pin 1 and pin 4 to the LED common.

[^2]:    Remark The graphs indicate nominal characteristics.

